

700V Super-Junction Power MOSFET

FEATURES

- Very low FOM R_{DS(on)}×Q_g
- 100% avalanche tested
- RoHS compliant

APPLICATIONS

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply (UPS)
- Power Factor Correction (PFC)

TO-3PN GDS	T0-247 G S G
RoHS	

Device Marking and Package Information			
Device	Package	Marking	
TPV70R110C	TO-3PN	70R110C	
TPW70R110C	TO-247	70R110C	

Absolute Maximum Ratings $T_c = 25^{\circ}C$, unless otherwise noted				
Parameter		Symbol	Value	Unit
Drain-Source Voltage ($V_{GS} = 0V$)		V _{DSS}	700	V
Continuous Drain Current		Ι _D	47	A
Pulsed Drain Current	(note1)	I _{DM}	141	A
Gate-Source Voltage		V _{GSS}	±30	V
Single Pulse Avalanche Energy	(note2)	E _{AS}	1120	mJ
Avalanche Current	(note1)	I _{AR}	15	A
Repetitive Avalanche Energy	(note1)	E _{AR}	1.76	mJ
Power Dissipation ($T_c = 25^{\circ}C$)		P _D	390	w
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55~+150	°C

Thermal Resistance			
Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case	R _{thJC}	0.32	K/W
Thermal Resistance, Junction-to-Ambient	R _{thJA}	62	r\/ VV



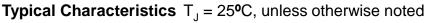
Parameter	Symbol Test C		Value			
		Test Conditions	Min.	Тур.	Max.	Unit
Static				- !		
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0V, I_{D} = 250\mu A$	700			V
	I _{DSS}	V _{DS} = 700V, V _{GS} = 0V, T _J = 25°C			1	- μΑ
Zero Gate Voltage Drain Current		V _{DS} = 700V, V _{GS} = 0V, T _J = 150°C			100	
Gate-Source Leakage	I _{GSS}	$V_{GS} = \pm 30V$			±100	nA
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	2.5		4.5	V
Drain-Source On-Resistance (Note3)	R _{DS(on)}	V _{GS} = 10V, I _D = 20A		0.08	0.11	Ω
Forward Transconductance (Note3)	g _{fs}	V _{DS} = 10V, I _D = 20A		40		S
Dynamic				•		
Input Capacitance	C _{iss}			5100		
Output Capacitance	C _{oss}	$V_{GS} = 0V,$ $V_{DS} = 50V,$		225		pF
Reverse Transfer Capacitance	C _{rss}	f = 1.0MHz		6.2		
Total Gate Charge	Q _g			90		
Gate-Source Charge	Q _{gs}	$V_{DD} = 560V, I_{D} = 47A, V_{GS} = 10V$		24		nC
Gate-Drain Charge	Q _{gd}			30		
Turn-on Delay Time	t _{d(on)}	V _{DD} = 400V, I _D = 26A,		16		
Turn-on Rise Time	t _r			12		
Turn-off Delay Time	t _{d(off)}	$R_{\rm G} = 1.7\Omega$		83		ns
Turn-off Fall Time	t _f			5		
Drain-Source Body Diode Characteris	stics					
Continuous Body Diode Current	I _s	T 0500			47	•
Pulsed Diode Forward Current	I _{SM}	T _C = 25°C			141	A
Body Diode Voltage	V _{SD}	$T_{J} = 25^{\circ}C, I_{SD} = 47A, V_{GS} = 0V$		0.9	1.2	V
Reverse Recovery Time	t _{rr}			720		ns
Reverse Recovery Charge	Q _{rr}	V _R = 400V, I _F = 26A, di _F /dt = 100A/µs		19		μC
Peak Reverse Recovery Current	I _{rrm}			52		А

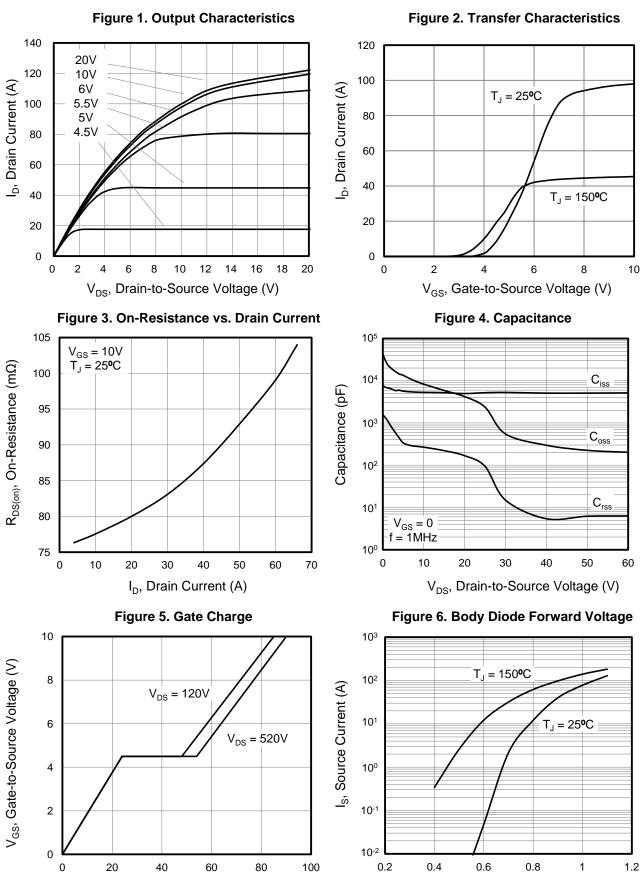
Notes

- 1. Repetitive Rating: Pulse Width limited by maximum junction temperature
- 2. I_{AS} = 15A, V_{DD} = 50V, R_{G} = 25 Ω , Starting T_{J} = 25°C
- 3. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 1%

E

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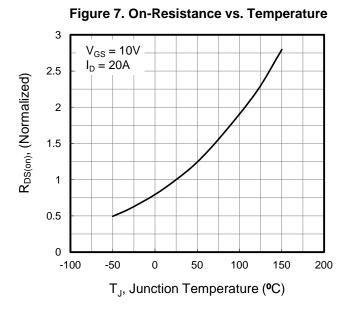


Q_q, Total Gate Charge (nC)

V_{SD}, Source-to-Drain Voltage (V)



Typical Characteristics $T_J = 25^{\circ}C$, unless otherwise noted



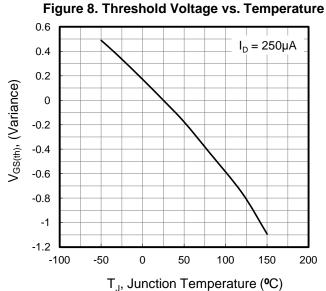
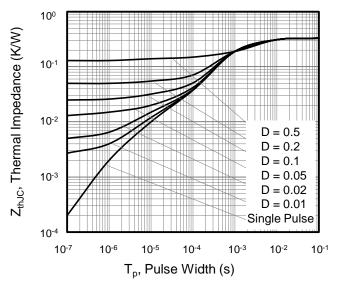
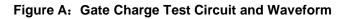


Figure 9. Transient Thermal Impedance





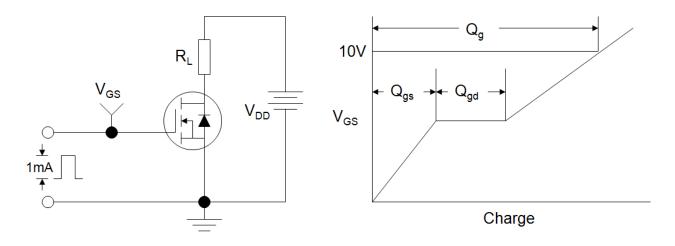


Figure B: Resistive Switching Test Circuit and Waveform

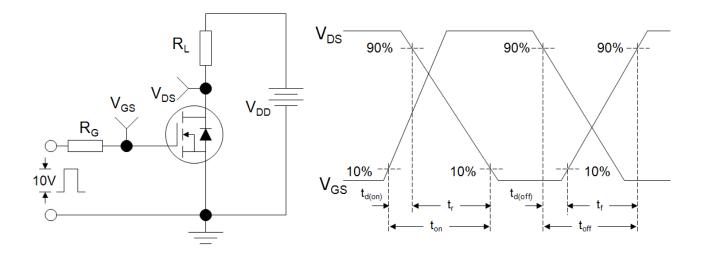
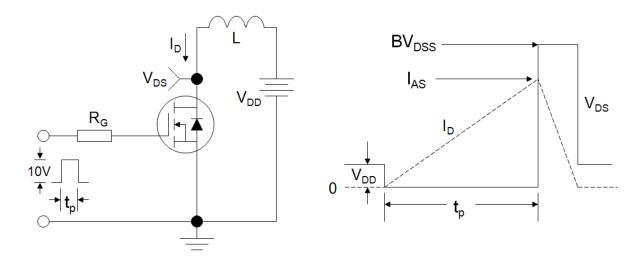
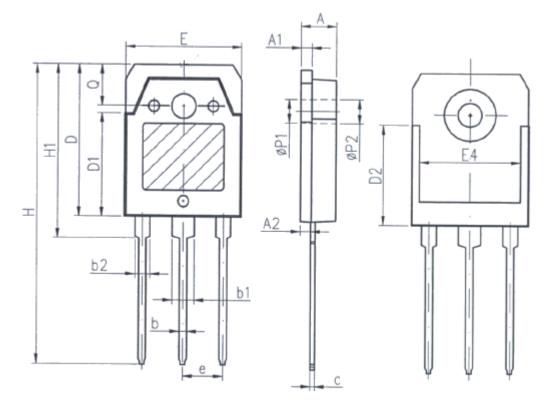


Figure C: Unclamped Inductive Switching Test Circuit and Waveform



B

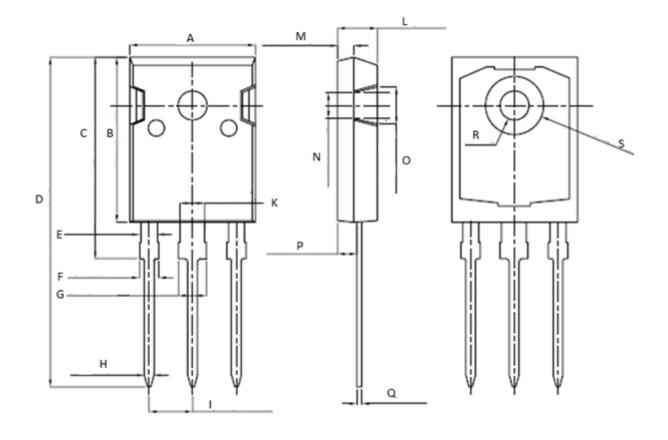
TO-3PN



Unit:mm			
Symbol	Min.	Max.	
Α	4.6	5	
A1	1.4	1.65	
A2	1.18	1. 58	
b	0.8	1.2	
b 1	2.8	3.2	
b2	1.8	2.2	
с	0.5	0.75	
D	19.6	20. 2	
D1	13.55	14. 25	
D2	12. 9	PREF	
E	15.35	15.85	
E4	12.6	-	
e	5. 45TYP		
н	40.1	40.9	
H1	23.15	23. 65	
P1	3. 2REF		
P2	3. 5REF		



TO-247



Unit: mm			
Symbol	Min.	Max.	
Α	15.95	16. 25	
В	20.85	21.25	
С	20.95	21.35	
D	40.5	40.9	
E	1.9	2.1	
F	2.1	2. 25	
G	3. 1	3. 25	
Н	1.1	1.3	
I	5.40	5.50	

Unit: mm			
Symbol	Min.	Max.	
K	2.90	3. 10	
L	4. 90	5.30	
М	1.90	2.10	
Ν	4. 50	4. 70	
0	5.40	5.60	
Р	2. 29	2. 49	
Q	0. 51	0. 71	
R	φ3.5	φ3.7	
S	φ7.1	φ7.3	



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